COMPLIANT

HALOGEN

**FREE** 

Vishay Siliconix

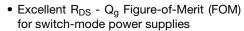
# N-Channel 30 V (D-S) MOSFET



PRODUCT SUMMARY				
V <sub>DS</sub> (V)	30			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.00122			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.00195			
Q <sub>g</sub> typ. (nC)	20.8			
I <sub>D</sub> (A)	191 <sup>a</sup>			
Configuration	Single			

### **FEATURES**

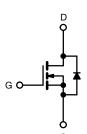
- TrenchFET® Gen IV power MOSFET
- 100 % R<sub>g</sub> and UIS tested



- 100 % R<sub>a</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



- High power density DC/DC
- · Synchronous rectification
- · Load switch
- OR-ing



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK® SO-8
Lead (Pb)-free, halogen-free, BLR and IOL	SiRA62DDP-T1-UE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	30	.,	
Gate-source voltage		$V_{GS}$	+20, -16	V	
Continuous drain current (T <sub>J</sub> = 150 °C)	$T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 70 ^{\circ}\text{C}$ $T_{A} = 25 ^{\circ}\text{C}$	I <sub>D</sub>	191 153 51 b, c 40 b, c		
$T_A = 70  ^{\circ}\text{C}$ Pulsed drain current (t = 100 $\mu$ s)		I <sub>DM</sub>	400	Α	
Continuous source-drain diode current	$T_C = 25  ^{\circ}C$ $T_A = 25  ^{\circ}C$	I <sub>S</sub>	65 4.6 <sup>b, c</sup>		
Single pulse avalanche current	1 0111	I <sub>AS</sub>	45		
Single pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	102	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C 71 T <sub>C</sub> = 70 °C 46		w		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	00	
Soldering recommendations (peak temperature) d, e			260	- °C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SMYBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, f	t ≤ 10 s	$R_{thJA}$	20	25	°C/W	
Maximum junction-to-case (drain)	Steady state	$R_{thJC}$	1.4	1.75		

- a. Based on T<sub>C</sub> = 25 °C
   b. Surface mounted on 1" x 1" FR4 board
- See solder profile (<a href="https://www.yishay.com/doc?73257">www.yishay.com/doc?73257</a>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components Maximum under steady state conditions is 70 °C/W



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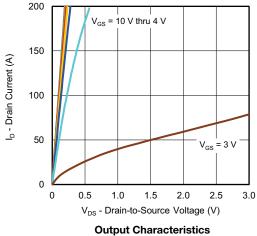
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 10 mA	-	20	-	m\//0C	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-4.9	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1	-	2.2	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = +20, -16 \text{ V}$	-	-	± 100	nA	
-		V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V	-	-	1	μΑ	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	10		
Duning and an adaptation and a	Б	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A	-	0.0010	0.00122	_	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$	-	0.0018	0.00195	Ω	
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 10 \text{ V}, I_D = 40 \text{ A}$	-	135	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	4344	-	pF	
Output capacitance	C <sub>oss</sub>	V 45VV 2VC 4.50	-	1680	-		
Reverse transfer capacitance	C <sub>rss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	67	-		
C <sub>rss</sub> /C <sub>iss</sub> ratio			-	0.0016	0.0032		
Total gate charge	0	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A	-	46.3	32		
Total gate charge	Q <sub>g</sub>		-	20.8	15		
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$	-	11.4	-	nC	
Gate-drain charge	$Q_{gd}$		-	2.4	-		
Output charge	Q <sub>oss</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V	-	50	-		
Gate resistance	Rg	f = 1 MHz	0.24	1.2	2.4	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	15	30		
Rise time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, R_L = 1.5 \Omega$	-	5	10		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	30	60		
Fall time	t <sub>f</sub>		-	5	10	no	
Turn-on delay time	t <sub>d(on)</sub>		-	30	60	ns	
Rise time	t <sub>r</sub>	$\begin{split} V_{DD} = 15 \text{ V}, \text{ R}_L = 1.5 \Omega \\ I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, \text{ R}_g = 1 \Omega \end{split}$	-	60	120		
Turn-off delay time	t <sub>d(off)</sub>		-	30	60		
Fall time	t <sub>f</sub>		-	10	20		
<b>Drain-Source Body Diode Characteristic</b>	cs						
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C -		-	65	^	
Pulse diode forward current <sup>a</sup>	I <sub>SM</sub>		-	-	400	Α	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 10 A	-	0.75	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	45	90	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	45	90	nC	
Reverse recovery fall time	ta	$T_{\rm J} = 25~{\rm ^{\circ}C}$	-	24.5	-	no	
Reverse recovery rise time	t <sub>b</sub>		-	20.5	-	ns	

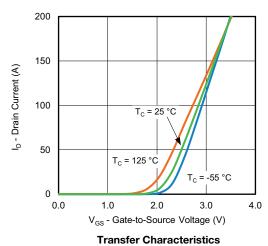
### Notes

- a. Pulse test: pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing
- c. Based on characterization, not subject to production testing

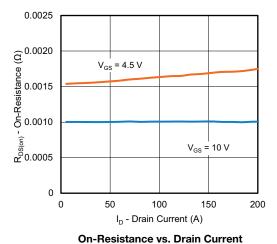
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

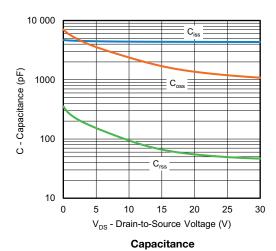


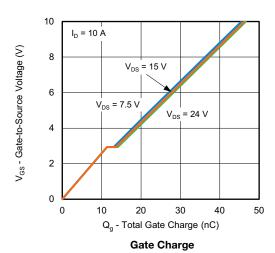


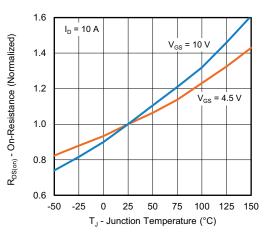






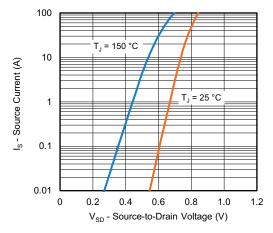




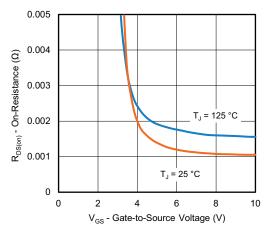


On-Resistance vs. Junction Temperature

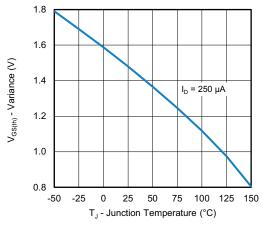




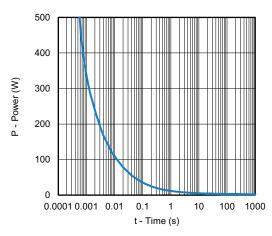
Source-Drain Diode Forward Voltage



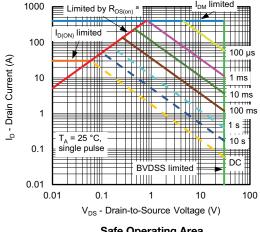
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



Single Pulse Power, Junction-to-Ambient



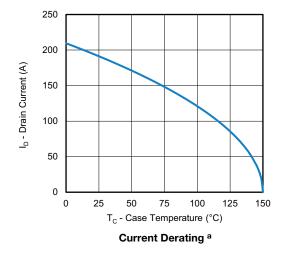
Safe Operating Area

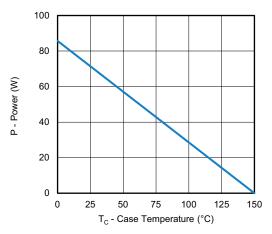
#### Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

In limited



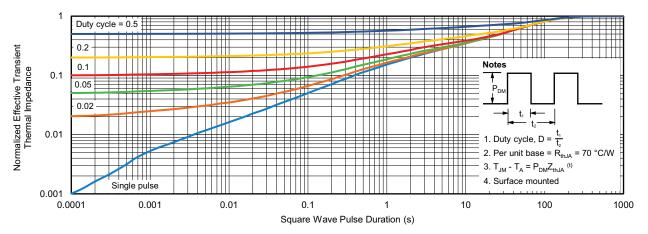




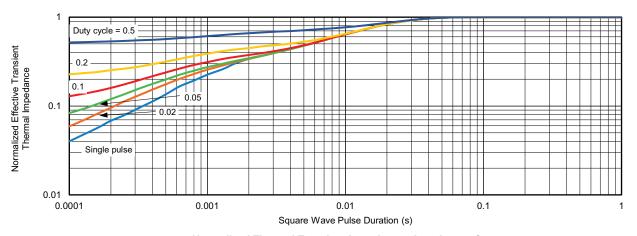
Power, Junction-to-Case

a. The power dissipation  $P_D$  is based on  $T_J$  max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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